



## Product Change Notification: MFOL-31SHMS864

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**Date:**

14-Jul-2026

**Product Category:**

Gate Drivers and Motor Drivers

**Notification Subject:**

CCB 8110 Final Notice: Qualification of MTAI as an additional assembly site for selected MIC4426, MIC4420, MIC4423, MIC4429, MIC4425, MIC4427, MIC4424, and MIC4428 device families available in 8L SOIC (3.90mm) package.

**Affected CPNs:**

[MFOL-31SHMS864\\_Affected\\_CPN\\_07142026.pdf](#)

[MFOL-31SHMS864\\_Affected\\_CPN\\_07142026.csv](#)

**PCN Status:** Final Notification

**PCN Type:** Manufacturing Change

**Microchip Parts Affected:** Please open one of the files found in the Affected CPNs section.

Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:** Qualification of MTAI as an additional assembly site for selected MIC4426, MIC4420, MIC4423, MIC4429, MIC4425, MIC4427, MIC4424, and MIC4428 device families available in 8L SOIC (3.90mm) package.

**Pre and Post Summary Changes:**

|               | Pre Change                        |                          | Post Change                       |                          |                               | Change<br>(Yes/No<br>) |
|---------------|-----------------------------------|--------------------------|-----------------------------------|--------------------------|-------------------------------|------------------------|
| Assembly Site | Stars Microelectronics (Thailand) | Unisem (M) Berhad Perak, | Stars Microelectronics (Thailand) | Unisem (M) Berhad Perak, | Microchip Technology Thailand | Yes                    |

|                                                     | Public Company<br>Limited (STAR)                           | Malaysia<br>(UNIS)     | Public Company<br>Limited (STAR) | Malaysia<br>(UNIS)     | (HQ)<br>(MTAI)               |     |
|-----------------------------------------------------|------------------------------------------------------------|------------------------|----------------------------------|------------------------|------------------------------|-----|
| <b>Wire<br/>Material</b>                            | Au                                                         | Au                     | Au                               | Au                     | CuPdAu                       | Yes |
| <b>Die<br/>Attach<br/>Material</b>                  | 2200D (PFAS)                                               | 8290<br>(PFAS<br>free) | 2200D (PFAS)                     | 8290<br>(PFAS<br>free) | CRM-<br>1064L<br>(PFAS free) | Yes |
| <b>Molding<br/>Compound<br/>Material</b>            | G600                                                       | G600KA                 | G600                             | G600KA                 | G634A                        | Yes |
| <b>Lead-<br/>Frame<br/>Material</b>                 | C194                                                       | A194                   | C194                             | A194                   | CDA194                       | No  |
| <b>Lead-<br/>Frame<br/>DAP<br/>Surface<br/>Prep</b> | NiPdAu                                                     | NiPdAu                 | NiPdAu                           | NiPdAu                 | Bare Cu                      | Yes |
| <b>Lead-<br/>Frame<br/>Lead<br/>Lock</b>            | No                                                         | No                     | No                               | No                     | Yes                          | Yes |
|                                                     | See Pre and Post Change Summary attachment for comparison. |                        |                                  |                        |                              | Yes |
| <b>Top<br/>Marking</b>                              | See Pre and Post Change Summary attachment for comparison. |                        |                                  |                        |                              | Yes |

Note: \*C194, A194 or CDA194 Lead frame material are the same, it is just a MCHP internal labelling difference.

**Impacts to Datasheet:** None

**Change Impact:** None

**Reason for Change:** To improve on-time delivery performance by qualifying MTAI as an additional assembly site.

**Change Implementation Status:** In Progress

**Estimated First Ship Date:** 10 August 2026 (date code: 2633)

**Note Below EFSD:** Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

**Timetable Summary:**

|                               | April 2026 |    |    |    |    | > | July 2026 |    |    |    |    | August 2026 |    |    |    |    |
|-------------------------------|------------|----|----|----|----|---|-----------|----|----|----|----|-------------|----|----|----|----|
| Work Week                     | 14         | 15 | 16 | 17 | 18 |   | 27        | 28 | 29 | 30 | 31 | 32          | 33 | 34 | 35 | 36 |
| Initial PCN Issue Date        |            | X  |    |    |    |   |           |    |    |    |    |             |    |    |    |    |
| Qual Report Availability      |            |    |    |    |    |   |           |    | X  |    |    |             |    |    |    |    |
| Final PCN Issue Date          |            |    |    |    |    |   |           |    | X  |    |    |             |    |    |    |    |
| Estimated Implementation Date |            |    |    |    |    |   |           |    |    |    |    |             | X  |    |    |    |

**Method to Identify Change:** Traceability Code

**Qualification Report:** Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

**Revision History:** April 08, 2026: Issued initial notification.

April 30, 2026: Re-issued initial notification to update LF DAP Surface Prep from "NiPdAu" to "Bare Cu" in Pre and Post Change Summary Attachment.

July 14, 2026: Issued final notification. Attached the qualification report. Provided estimated first ship date to be on August 10, 2026.

**Note:** The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable product.

## Attachments:

**PCN\_MFOL-31SHMS864\_Pre and\_Post\_Change\_Summary.pdf**  
**PCN\_MFOL-31SHMS864\_Qual\_Report.pdf**

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

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If you wish to change your PCN profile, including opt out, please go to the [PCN home page](#) select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

Affected Catalog Part Numbers (CPN):

MIC4426ZM

MIC4426ZM-TR

MIC4420YM

MIC4420YM-TR

MIC4423YM

MIC4423YM-TR

MIC4429ZM

MIC4429ZM-TR

MIC4425YM

MIC4425YM-TR

MIC4427ZM

MIC4427ZM-TR

MIC4424YM

MIC4424YM-TR

MIC4429YM

MIC4429YM-TR

MIC4428YM

MIC4428YM-TR

MIC4420ZM

MIC4420ZM-TR

MIC4426YM

MIC4426YM-TR

MIC4428ZM

MIC4428ZM-TR

MIC4427YM

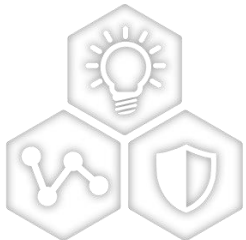
MIC4427YM-TR

**CCB 8110**  
**Pre and Post Change Summary**  
**PCN ID#: MFOL-31SHMS864**



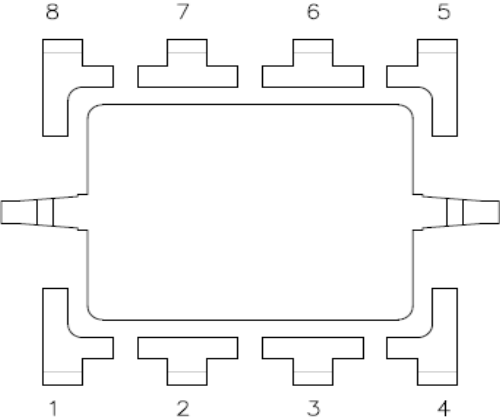
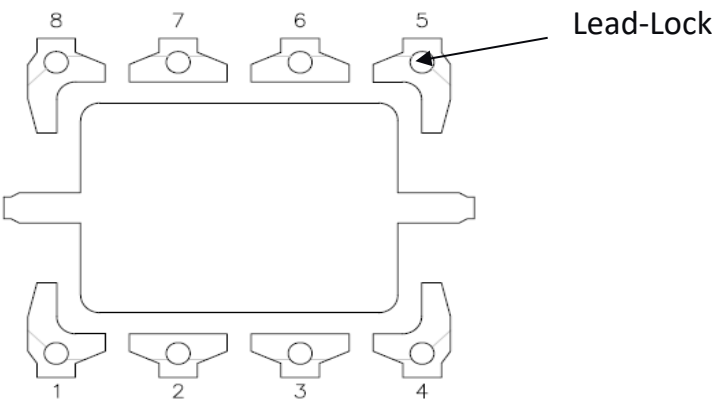
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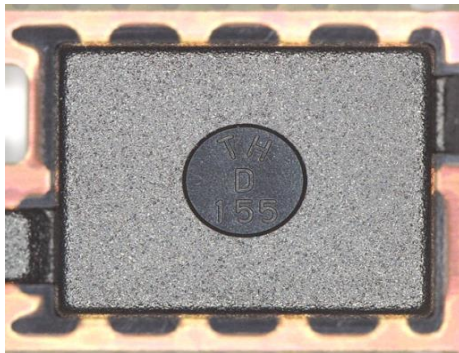
# Pre and Post Summary – Lead Frame Comparison

| STAR and UNIS                                                                                                                                                                                                                                                                                                | MTAI                |              |                             |        |                      |    |                                                                                                                                                                                                                                                                                                               |                     |         |                             |         |                      |       |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------|--------------|-----------------------------|--------|----------------------|----|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------|---------|-----------------------------|---------|----------------------|-------|
| <div><p>Note: Not to scale</p></div> <table><tr><td>Lead-Frame Material</td><td>C194 / A194*</td></tr><tr><td>Lead-Frame DAP Surface Prep</td><td>NiPdAu</td></tr><tr><td>Lead-Frame Lead Lock</td><td>No</td></tr></table> | Lead-Frame Material | C194 / A194* | Lead-Frame DAP Surface Prep | NiPdAu | Lead-Frame Lead Lock | No | <div><p>Note: Not to scale</p></div> <table><tr><td>Lead-Frame Material</td><td>CDA194*</td></tr><tr><td>Lead-Frame DAP Surface Prep</td><td>Bare Cu</td></tr><tr><td>Lead-Frame Lead Lock</td><td>Yes**</td></tr></table> | Lead-Frame Material | CDA194* | Lead-Frame DAP Surface Prep | Bare Cu | Lead-Frame Lead Lock | Yes** |
| Lead-Frame Material                                                                                                                                                                                                                                                                                          | C194 / A194*        |              |                             |        |                      |    |                                                                                                                                                                                                                                                                                                               |                     |         |                             |         |                      |       |
| Lead-Frame DAP Surface Prep                                                                                                                                                                                                                                                                                  | NiPdAu              |              |                             |        |                      |    |                                                                                                                                                                                                                                                                                                               |                     |         |                             |         |                      |       |
| Lead-Frame Lead Lock                                                                                                                                                                                                                                                                                         | No                  |              |                             |        |                      |    |                                                                                                                                                                                                                                                                                                               |                     |         |                             |         |                      |       |
| Lead-Frame Material                                                                                                                                                                                                                                                                                          | CDA194*             |              |                             |        |                      |    |                                                                                                                                                                                                                                                                                                               |                     |         |                             |         |                      |       |
| Lead-Frame DAP Surface Prep                                                                                                                                                                                                                                                                                  | Bare Cu             |              |                             |        |                      |    |                                                                                                                                                                                                                                                                                                               |                     |         |                             |         |                      |       |
| Lead-Frame Lead Lock                                                                                                                                                                                                                                                                                         | Yes**               |              |                             |        |                      |    |                                                                                                                                                                                                                                                                                                               |                     |         |                             |         |                      |       |

Note: \* C194, A194 or CDA194 Lead frame material are the same, it is just a MCHP internal labelling difference.

Note:\*\* Mold compound materials fills the leadlock hole, which provides improved protection against moisture penetration along the edge of the leads (pins) of the package.

# Pre and Post Summary – Top Marking

| STAR and UNIS                                                                                                                                                                                                                                                                                                                                                                                                                    | MTAI                                                                                                   |              |              |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |      |   |              |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                         |         |  |  |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------|--------------|--------------|--|----------|------|------|--------------|-------|---|--------------|----------|-------|---|--------------|----|-------|---|--------------|---------|------|---|--------------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|--|--|--|----------|------|------|--------------|-------|---|--------------|----------|-------|---|--------------|----|-------|---|--------------|---------|
| <p>Top Marking : Line 1-3. Back side marking: Line 4 is Country Of Origin (COO)</p>                                                                                                                                                                                                                                                                                                                                              | <p>Top Marking : Line 1-3. No Back side marking. COO is TH engraved on the backside of the package</p> |              |              |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |      |   |              |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                         |         |  |  |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |
| <table><tr><th colspan="4">Marking</th></tr><tr><th>Location</th><th>Line</th><th>Area</th><th>Marking data</th></tr><tr><td>FRONT</td><td>1</td><td>AssemblyMark</td><td>&lt;MC&gt;4423</td></tr><tr><td>FRONT</td><td>2</td><td>AssemblyMark</td><td>YM</td></tr><tr><td>FRONT</td><td>3</td><td>AssemblyMark</td><td>&lt;O&gt;WNNN</td></tr><tr><td>BACK</td><td>1</td><td>AssemblyMark</td><td>&lt;COO&gt;</td></tr></table> | Marking                                                                                                |              |              |  | Location | Line | Area | Marking data | FRONT | 1 | AssemblyMark | <MC>4423 | FRONT | 2 | AssemblyMark | YM | FRONT | 3 | AssemblyMark | <O>WNNN | BACK | 1 | AssemblyMark | <COO> | <table><tr><th colspan="4">Marking</th></tr><tr><th>Location</th><th>Line</th><th>Area</th><th>Marking data</th></tr><tr><td>FRONT</td><td>1</td><td>AssemblyMark</td><td>&lt;MC&gt;4423</td></tr><tr><td>FRONT</td><td>2</td><td>AssemblyMark</td><td>YM</td></tr><tr><td>FRONT</td><td>3</td><td>AssemblyMark</td><td>&lt;O&gt;WNNN</td></tr></table> <div></div> | Marking |  |  |  | Location | Line | Area | Marking data | FRONT | 1 | AssemblyMark | <MC>4423 | FRONT | 2 | AssemblyMark | YM | FRONT | 3 | AssemblyMark | <O>WNNN |
| Marking                                                                                                                                                                                                                                                                                                                                                                                                                          |                                                                                                        |              |              |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |      |   |              |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                         |         |  |  |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |
| Location                                                                                                                                                                                                                                                                                                                                                                                                                         | Line                                                                                                   | Area         | Marking data |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |      |   |              |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                         |         |  |  |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |
| FRONT                                                                                                                                                                                                                                                                                                                                                                                                                            | 1                                                                                                      | AssemblyMark | <MC>4423     |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |      |   |              |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                         |         |  |  |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |
| FRONT                                                                                                                                                                                                                                                                                                                                                                                                                            | 2                                                                                                      | AssemblyMark | YM           |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |      |   |              |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                         |         |  |  |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |
| FRONT                                                                                                                                                                                                                                                                                                                                                                                                                            | 3                                                                                                      | AssemblyMark | <O>WNNN      |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |      |   |              |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                         |         |  |  |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |
| BACK                                                                                                                                                                                                                                                                                                                                                                                                                             | 1                                                                                                      | AssemblyMark | <COO>        |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |      |   |              |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                         |         |  |  |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |
| Marking                                                                                                                                                                                                                                                                                                                                                                                                                          |                                                                                                        |              |              |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |      |   |              |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                         |         |  |  |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |
| Location                                                                                                                                                                                                                                                                                                                                                                                                                         | Line                                                                                                   | Area         | Marking data |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |      |   |              |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                         |         |  |  |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |
| FRONT                                                                                                                                                                                                                                                                                                                                                                                                                            | 1                                                                                                      | AssemblyMark | <MC>4423     |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |      |   |              |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                         |         |  |  |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |
| FRONT                                                                                                                                                                                                                                                                                                                                                                                                                            | 2                                                                                                      | AssemblyMark | YM           |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |      |   |              |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                         |         |  |  |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |
| FRONT                                                                                                                                                                                                                                                                                                                                                                                                                            | 3                                                                                                      | AssemblyMark | <O>WNNN      |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |      |   |              |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                         |         |  |  |  |          |      |      |              |       |   |              |          |       |   |              |    |       |   |              |         |





## **QUALIFICATION SUMMARY REPORT**

**RELIABILITY LABORATORY**

**PCN #: MFOL-31SHMS864**

Date:  
July 13, 2026

**Qualification of MTAI as an additional assembly site for selected MIC4426, MIC4420, MIC4423, MIC4429, MIC4425, MIC4427, MIC4424, and MIC4428 device families available in 8L SOIC (3.90mm) package.**

## PACKAGE QUALIFICATION REPORT

### Purpose:

Qualification of MTAI as an additional assembly site for selected MIC4426, MIC4420, MIC4423, MIC4429, MIC4425, MIC4427, MIC4424, and MIC4428 device families available in 8L SOIC (3.90mm) package.

**CN:** E000303030  
**QUAL ID:** R2600382 Rev. A  
**MP CODE:** 248037C2XAA1  
**Part No.:** MIC4423YM  
**Bonding No.:** BD-004036-01  
**CCB No.:** 8110

### Lead Frame

**Paddle Size:** 95 x 130  
**Material:** CDA194  
**DAP Surface Prep:** Bare Cu  
**Process:** Stamped  
**Lead Lock:** Yes, lead lock hole  
**Part Number:** 101000842  
**Plating Composition:** Matte tin

### Bond Wire

**Wire:** CuPdAu wire

### Die Attach Material

**Epoxy:** CRM-1064L (PFAS-Free)  
**Conductive:** Yes

### Mold Compound

**Mold Compound:** G634A (PFAS-Free)

### Package

**Type:** 8L SOIC  
**Package Size:** 150 mils

## PACKAGE QUALIFICATION REPORT

### Manufacturing Information

| Assembly Lot No.  |
|-------------------|
| MTAI265000398.000 |
| MTAI264901227.000 |
| MTAI265000394.000 |

Result: **Pass**

### Conclusion:

24803 mask / MIC4423YM product / CuPdAu wire in 8L SOIC 150 mils package at MTAI site is qualified for MSL1 at 260°C as per JEDEC J-STD-020 standard and is passed in accordance to Specified JEDEC and Mil Standards.

## PACKAGE QUALIFICATION REPORT

| Test                                         | Test Condition                                                                                                                | Standard / Method            | Qty. (Acc.)                 | Def/SS                                                                                                                                | Result |
|----------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------|------------------------------|-----------------------------|---------------------------------------------------------------------------------------------------------------------------------------|--------|
| Moisture Soak Precondition Prior to Stresses | MSL1: 150°C 24 hours Bake, 168 hours Moisture Soak at 85°C/85%RH, 3x Reflow at 260°C Electrical Test Tester: TMT_MCRS_NT 85°C | JESD22-A113, JEDEC J-STD-020 | 231 units each lot / 3 lots | 0/231 (R26 00382-1 M TAI265000 398.000), 0/231 (R26 00382-2 M TAI264901 227.000), 0/231 (R26 00382-3 M TAI265000 394.000) Electrical; | Pass   |

| Test              | Test Condition                                             | Standard / Method | Qty. (Acc.)       | Def/SS                                                                                                                 | Result |
|-------------------|------------------------------------------------------------|-------------------|-------------------|------------------------------------------------------------------------------------------------------------------------|--------|
| High Temp Storage | 175°C / 504 hours Electrical Test Tester: TMT_MCRS_NT 85°C | JESD22-A103       | 45 units / 3 lots | 0/45 (R260 0382-1 MT AI2650003 98.000), 0/45 (R260 0382-2 MT AI2649012 27.000), 0/45 (R260 0382-3 MT AI2650003 94.000) | Pass   |

| Test                | Test Condition                                                                  | Standard / Method | Qty. (Acc.)                | Def/SS                                                                                                                                                      | Result |
|---------------------|---------------------------------------------------------------------------------|-------------------|----------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| Temperature Cycling | -65°C / +150°C Air to Air / 500 Cycles Electrical Test Tester: TMT_MCRS_NT 85°C | JESD22-A104       | 77 units each lot / 3 lots | Electrical: 0/77 (R260 0382-1 MT AI2650003 98.000), 0/77 (R260 0382-2 MT AI2649012 27.000), 0/77 (R260 0382-3 MT AI2650003 94.000); WBP: 0/5 ( R2600382-1), | Pass   |

## PACKAGE QUALIFICATION REPORT

| Test        | Test Condition                                                                             | Standard / Method | Qty. (Acc.)                   | Def/SS                                                                                                                                                  | Result |
|-------------|--------------------------------------------------------------------------------------------|-------------------|-------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| Biased HAST | +130°C / 85%RH / 96 hours / Bias Voltage: 5.5V<br>Electrical Test Tester: TMT_MCRS_NT 85°C | JESD22-A110       | 77 units each<br>lot / 3 lots | 0/77 (R260<br>0382-1 MT<br>AI2650003<br>98.000),<br>0/77 (R260<br>0382-2 MT<br>AI2649012<br>27.000),<br>0/77 (R260<br>0382-3 MT<br>AI2650003<br>94.000) | Pass   |

| Test          | Test Condition                                                        | Standard / Method | Qty. (Acc.)                   | Def/SS                                                                                                                                                  | Result |
|---------------|-----------------------------------------------------------------------|-------------------|-------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| Unbiased HAST | +130°C / 85%RH / 96 hours Electrical Test<br>Tester: TMT_MCRS_NT 85°C | JESD22-A118       | 77 units each<br>lot / 3 lots | 0/77 (R260<br>0382-1 MT<br>AI2650003<br>98.000),<br>0/77 (R260<br>0382-2 MT<br>AI2649012<br>27.000),<br>0/77 (R260<br>0382-3 MT<br>AI2650003<br>94.000) | Pass   |

| Test                                           | Test Condition                                                            | Standard / Method          | Qty. (Acc.)      | Def/SS | Result |
|------------------------------------------------|---------------------------------------------------------------------------|----------------------------|------------------|--------|--------|
| Solderability (0 Hr)<br>Method 1: Dip and Look | Pb-free 8 hours Steam age. Dip at 245°C,<br>100% leads >95% lead coverage | J-STD-002 /<br>JESD22B-102 | 22 units / 1 lot | 0/22   | Pass   |

| Test                        | Test Condition                   | Standard / Method       | Qty. (Acc.)                   | Def/SS | Result |
|-----------------------------|----------------------------------|-------------------------|-------------------------------|--------|--------|
| Physical Dimension<br>(0Hr) | Within package diagram dimension | JESD22 B100<br>and B108 | 10 units each<br>lot / 3 lots | 0/30   | Pass   |

| Test      | Test Condition              | Standard / Method     | Qty. (Acc.)     | Def/SS | Result |
|-----------|-----------------------------|-----------------------|-----------------|--------|--------|
| Wire Pull | Bond Strength Data Assembly | Mil. Std.<br>883-2011 | 5 units / 1 lot | 0/5    | Pass   |

PACKAGE QUALIFICATION REPORT

| Test       | Test Condition              | Standard / Method | Qty. (Acc.)     | Def/SS | Result |
|------------|-----------------------------|-------------------|-----------------|--------|--------|
| Bond Shear | Bond Strength Data Assembly | CDF-AEC-Q100-001  | 5 units / 1 lot | 0/5    | Pass   |